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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









# HMC322LP4 / 322LP4E

v06.0112



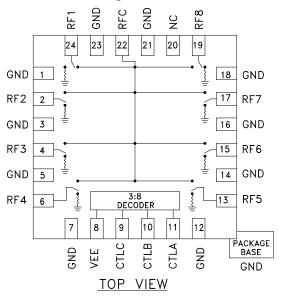
# GaAs MMIC SP8T NON-REFLECTIVE SWITCH. DC - 8 GHz

#### Typical Applications

This switch is suitable for usage in DC - 8.0 GHz 50-Ohm or 75-Ohm systems:

- Broadband
- Fiber Optics
- Switched Filter Banks
- Wireless below 8 GHz

### **Functional Diagram**



#### **Features**

Broadband Performance: DC - 8.0 GHz

High Isolation: >30 dB@ 6 GHz

Low Insertion Loss: 2.4 dB@ 6 GHz

Integrated 3:8 TTL Decoder

24 Lead 4x4mm QFN Package: 9 mm<sup>2</sup>

### **General Description**

The HMC322LP4 & HMC322LP4E are broadband non-reflective GaAs MESFET SP8T switches in low cost leadless surface mount packages. Covering DC to 8 GHz, this switch offers high isolation and low insertion loss. This switch also includes an on board binary decoder circuit which reduces the required logic control lines to three. The switch operates using a negative control voltage of 0/-5 volts, and requires a fixed bias of -5V. This switch is suitable for usage in 50-Ohm or 75-Ohm systems.

# Electrical Specifications, $T_A = +25^{\circ}$ C, With 0/-5V Control, 50 Ohm System

| Parameter   |             | Frequency  | Min.                 | Тур.                 | Max.              | Units                |
|---|-------------|--|----------------------|----------------------|-------------------|----------------------|
| Insertion Loss  |             | DC - 2.0 GHz<br>DC - 4.0 GHz<br>DC - 8.0 GHz                 |                      | 2.1<br>2.3<br>2.5    | 2.5<br>2.7<br>2.9 | dB<br>dB<br>dB       |
| Isolation   |             | DC - 2.0 GHz<br>DC - 4.0 GHz<br>DC - 6.0 GHz<br>DC - 8.0 GHz | 35<br>30<br>25<br>20 | 40<br>35<br>30<br>25 |                   | dB<br>dB<br>dB<br>dB |
| Return Loss   | "On State"  | DC - 2.0 GHz<br>DC - 8.0 GHz                                 | 9<br>6               | 12<br>10             |                   | dB<br>dB             |
| Return Loss   | "Off State" | DC - 8.0 GHz   | 7                    | 10                   |                   | dB                   |
| Input Power for 1 dB Compression  |             | 0.5 - 8.0 GHz  | 19                   | 23                   |                   | dBm                  |
| Input Third Order Intercept<br>(Two-Tone Input Power = +7 dBm Each Tone)                  |             | 0.5 - 8.0 GHz  | 36                   | 40                   |                   | dBm                  |
| Switching Characteristics<br>tRISE, tFALL (10/90% RF)<br>tON, tOFF (50% CTL to 10/90% RF) |             | DC - 8.0 GHz   |                      | 50<br>150            |                   | ns<br>ns             |

# **HMC322\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 02/23/2017

# COMPARABLE PARTS -

View a parametric search of comparable parts.

### **EVALUATION KITS**

• HMC322LP4 Evaluation Board.

### **DOCUMENTATION**

#### **Data Sheet**

- HMC322 Die Data Sheet
- HMC322LP4 Data Sheet

## REFERENCE MATERIALS 🖵

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Package/Assembly Qualification Test Report: Plastic Encapsulated QFN (QTR: 05006 REV: 02)
- Semiconductor Qualification Test Report: MESFET-F (QTR: 2013-00247)

# **DESIGN RESOURCES**

- HMC322 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC322 EngineerZone Discussions.

## SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

## **TECHNICAL SUPPORT**

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK 🖳

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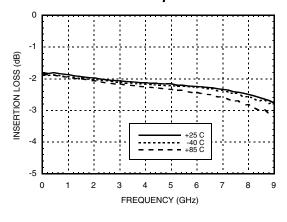
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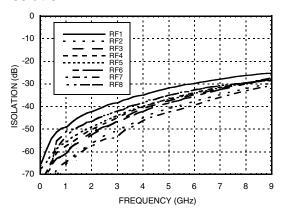


# GaAs MMIC SP8T NON-REFLECTIVE SWITCH, DC - 8 GHz

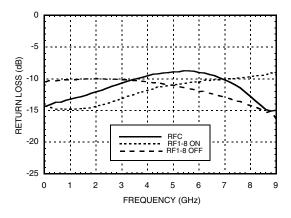
#### Insertion Loss vs. Temperature



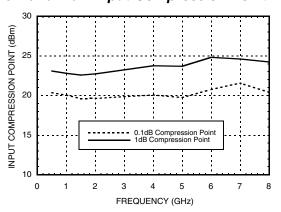
#### Isolation



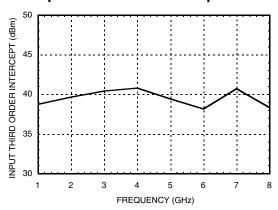
#### **Return Loss**



### 0.1 and 1 dB Input Compression Point



#### **Input Third Order Intercept Point**







# GaAs MMIC SP8T NON-REFLECTIVE SWITCH, DC - 8 GHz

### Bias Voltage & Current

| Vee Range = -5.0 Vdc ± 10% |                    |                    |  |
|----------------------------|--------------------|--------------------|--|
| Vee<br>(Vdc)               | lee (Typ.)<br>(mA) | lee (Max.)<br>(mA) |  |
| -5.0                       | 5.0                | 9.0                |  |

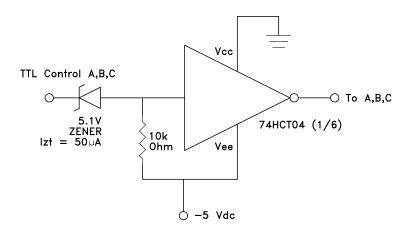
### **Control Voltages**

| State | Bias Condition                |
|-------|-------------------------------|
| Low   | -3V to 0 Vdc @ 25 μA Typical  |
| High  | -5 to -4.2 Vdc @ 5 μA Typical |

#### **Truth Table**

| Control Input |      | it   | Signal Path State |  |
|---------------|------|------|-------------------|--|
| Α             | В    | С    | RFCOM to:         |  |
| High          | High | High | RF1               |  |
| Low           | High | High | RF2               |  |
| High          | Low  | High | RF3               |  |
| Low           | Low  | High | RF4               |  |
| High          | High | Low  | RF5               |  |
| Low           | High | Low  | RF6               |  |
| High          | Low  | Low  | RF7               |  |
| Low           | Low  | Low  | RF8               |  |

#### **TTL Interface Circuit**



#### Note:

Control inputs A, B, and C can be driven directly with TTL logic with -5 Volts applied to the HCT logic gates Vee pin and to Vee (pin 8) of the RF Switch.





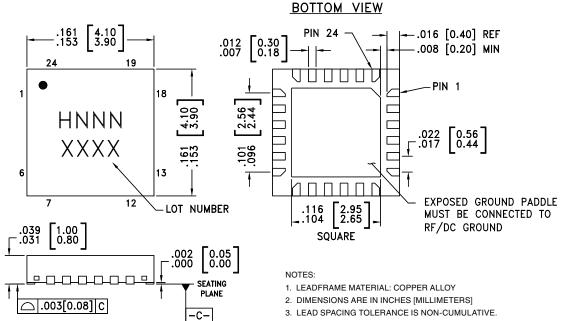
# GaAs MMIC SP8T NON-REFLECTIVE SWITCH, DC - 8 GHz

### Absolute Maximum Ratings

| Bias Voltage Range (Vee)                                 | -7.0 Vdc              |  |
|--|-----------------------|--|
| Control Voltage Range<br>(A, B, & C)                     | Vee -0.5V to +1.0 Vdc |  |
| Storage Temperature                                      | -65 to +150 °C        |  |
| Operating Temperature                                    | -40 to +85 °C         |  |
| Maximum Input Power                                      | 26 dBm                |  |
| Channel Temperature                                      | 150 ° C               |  |
| Continuous Pdiss ( T = 85 ° C ) ( derate 5.34 mW / ° C ) | 0.348 W               |  |
| Thermal Resistance                                       | 187 ° C / W           |  |
| ESD Sensitivity (HBM)                                    | Class 1B              |  |



### **Outline Drawing**



- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

#### **Package Information**

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating | Package Marking [3] |
|-------------|--|---------------|------------|---------------------|
| HMC322LP4   | Low Stress Injection Molded Plastic                | Sn/Pb Solder  | MSL1 [1]   | H322<br>XXXX        |
| HMC322LP4E  | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2]   | H322<br>XXXX        |

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX





# GaAs MMIC SP8T NON-REFLECTIVE SWITCH, DC - 8 GHz

### **Pin Descriptions**

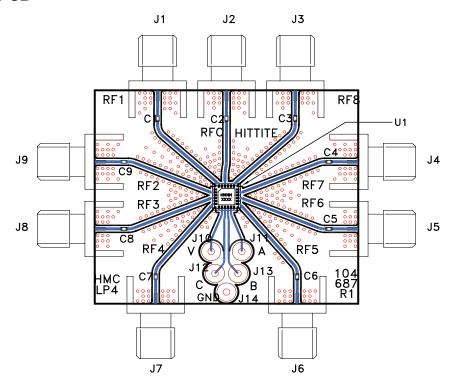
| Pin Number                               | Function           | Description   | Interface Schematic |
|--|--------------------|---|---------------------|
| 1, 3, 5, 7,<br>12, 14, 16,<br>18, 21, 23 | GND                | Package bottom has exposed metal paddle that must also be connected to PCB RF ground.                                   | ⊖ GND<br>=          |
| 2, 4, 6,<br>13, 15, 17,<br>19, 22, 24    | RF1 - RF8<br>& RFC | This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required if RF line potential is not equal to 0V. |                     |
| 8  | VEE                | Supply Voltage = -5V ± 10%  | VEE 0               |
| 9  | CTLC               | See truth table and control voltage table.  |                     |
| 10                                       | CTLB               | See truth table and control voltage table.  | 200K                |
| 11                                       | CTLA               | See truth table and control voltage table.  | VEE                 |
| 20                                       | N/C                | This pin should be connected to PCB RF ground to maximize isolation.  |                     |





# GaAs MMIC SP8T NON-REFLECTIVE SWITCH, DC - 8 GHz

#### **Evaluation PCB**



#### List of Materials for Evaluation PCB 107780 [1]

| Item      | Description                        |  |
|-----------|------------------------------------|--|
| J1 - J9   | PCB Mount SMA RF Connector         |  |
| J10 - J14 | DC Pin                             |  |
| C1 - C9   | 100 pF Capacitor, 0402 Pkg.        |  |
| U1        | HMC322LP4 / HMC322LP4E SP8T Switch |  |
| PCB [2]   | 104687 Evaluation PCB 1.73"x1.46"  |  |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.